

## SUPER FAST DIODE MODULE TYPE 600A

### Features

High Surge Capability  
Type 1200V  $V_{RRM}$   
Isolation Type Package  
Electrically Isolation base plate

### Maximum Ratings

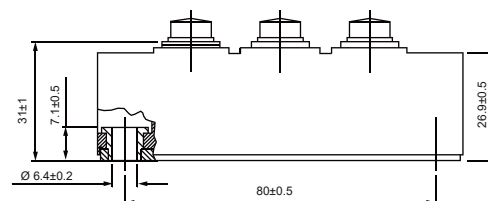
Operating Temperature : -55°C to +175°C  
Storage Temperature : -55°C to +175°C

Part Number	Maximum Recurrent Peak Reverse Voltage	Maximum RMS Voltage	Maximum DC Blocking Voltage
MURKA600120(A)(R)	1200V	840V	1200V

### HEAVY THREE TOWER KA

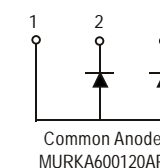
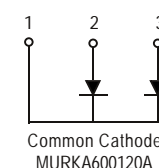
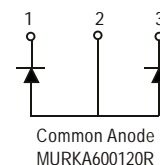
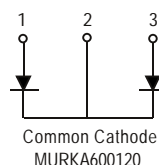
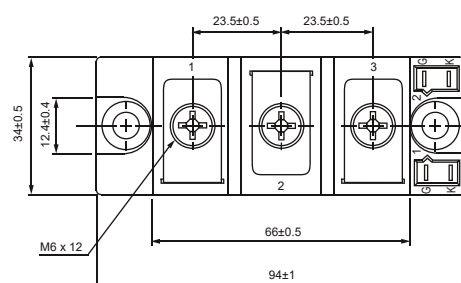


Dimensions in mm (1 mm = 0.0394")



### Electrical Characteristics @ 25 °C Unless Otherwise Specified

Average Forward Current (Per pkg)	$I_{F(AV)}$	600A	$T_C = 100^\circ\text{C}$
Peak Forward Surge Current (Per diode)	$I_{FSM}$	6000A	8.3ms , half sine
Maximum Instantaneous Forward Voltage * (Per diode)	$V_F$	2.35V	$I_{FM} = 300\text{A}; T_J = 25^\circ\text{C}$
Maximum Instantaneous Reverse Current At Rated DC Blocking Voltage* (Per diode)	$I_R$	50 $\mu\text{A}$ 6 mA	$T_J = 25^\circ\text{C}$ $T_J = 125^\circ\text{C}$
Maximum Reverse Recovery Time (Per diode)	$T_{rr}$	250ns	$I_F = 0.5\text{A}, I_R = 1.0\text{A}, I_{RR} = 0.25\text{A}$
Isolation Voltage	$V_{isol}$	3000V	A.C. 1minute
Maximum Thermal Resistance Junction To Case	$R_{\theta jc}$	0.14°C/W 0.28°C/W	Per pkg Per diode
Mounting torque	$M_d$	2.5±0.5Nm 4.5±0.5Nm	To heatsink To terminal



\*Pulse Test: Pulse Width 300  $\mu\text{sec}$ , Duty Cycle < 2%

Figure .1- Typical Forward Characteristics

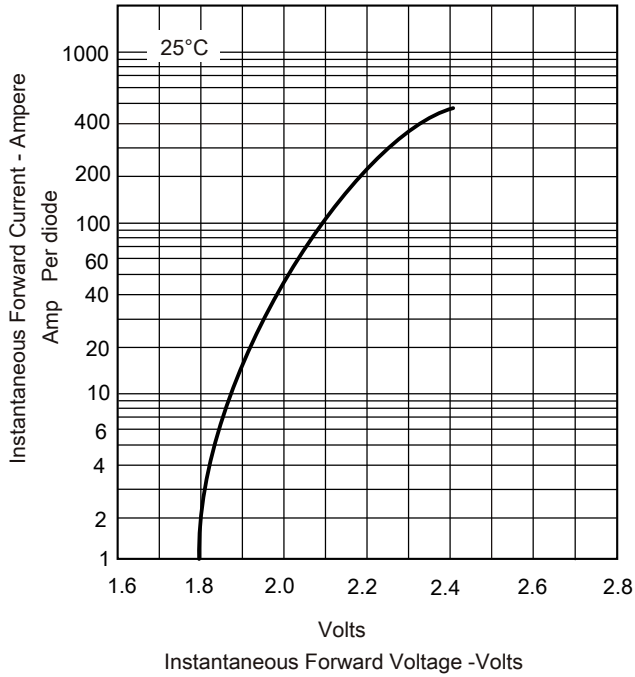


Figure .2-Forward Derating Curve

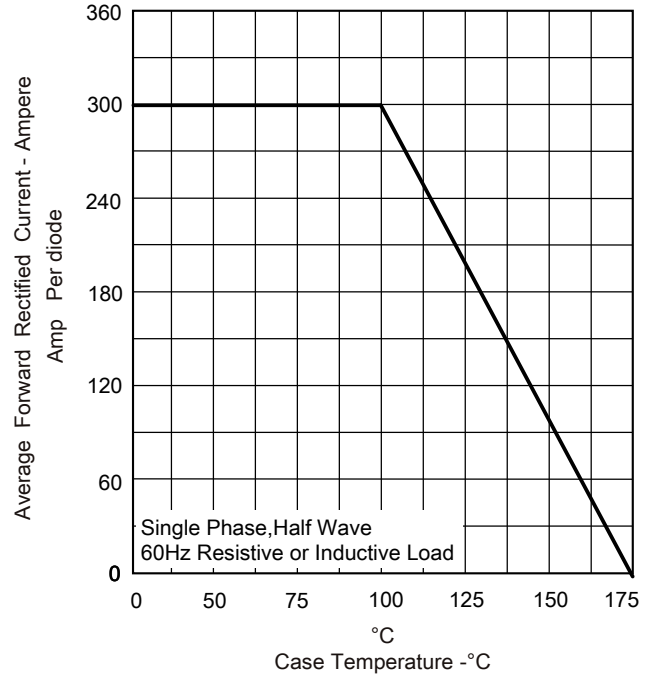


Figure .3-Peak Forward Surge Current

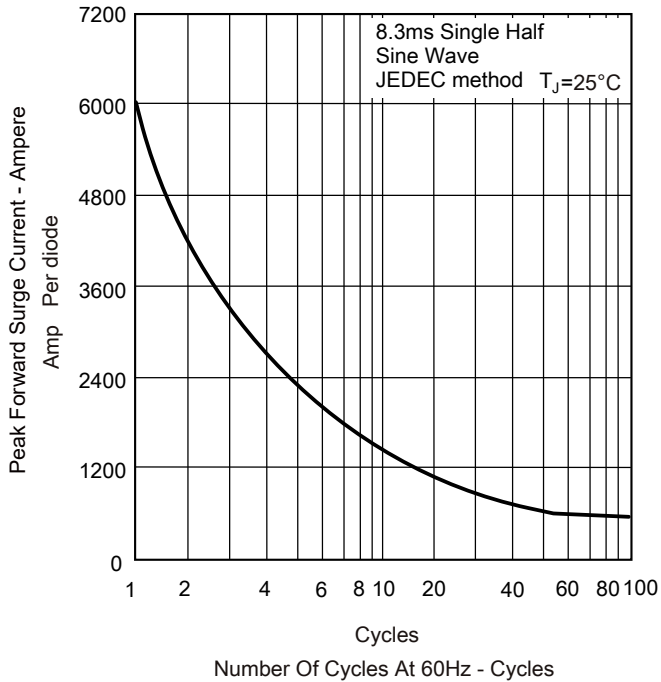
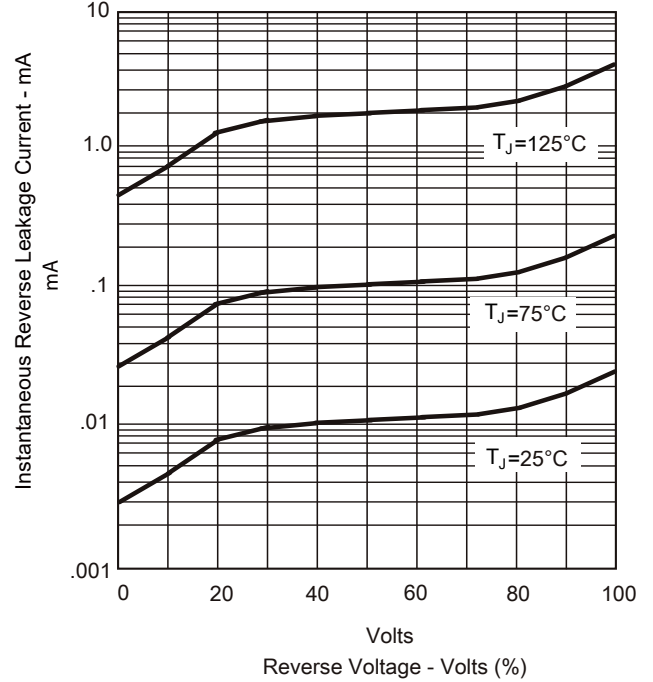


Figure .4-Typical Reverse Characteristics



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